



## **Features**

- High speed up to 6000/6400/6800MT/s
- Heat sink design enhances memory dissipation
- intel XMP 3.0 and AMD EXPO Support
- Compatibility with intel and AMD platforms
- Carefully selected high-quality chips from original

## manufacturers

- Meeting JEDEC standards
- Built-in Power Management IC
- Support On-die ECC error correction functionality
- High-quality PCB provides improved signal transfer and system stability

## Ordering Information

Speed	Capacity	CL	EAN Code	Part Number
6000 MT/s	32GB(16GBx2)	30	4718009613119	AGI6AWB16UD858
6400 MT/s	32GB(16GBx2)	32	4718009613126	AGI6GWB16UD858
6400 MT/s	32GB(16GBx2)	36	4718009614215	AGI6IWB16UD858
6800 MT/s	32GB(16GBx2)	34	4718009613133	AGI6JWB16UD858

## Specifications

• Capacity: 32GB (16GB x2)

• Module: 288-pin UDIMM

• Operating voltage: 1.35/1.4V

Heat Sink Color: Black

Operating temperature: 0°C to 85°C

• Dimensions (L x W): 137.35 x 33.4 mm

• Weight: 65g (2pcs)

• Warranty: Limited lifetime

**Dual Tray** 

